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Halvledarkomponenter – Halvledargränssnitt för kommunikation genom människokroppen (HBC) – Del 1: Allmänna fordringar

*Semiconductor devices –
Semiconductor interface for human body communication –
Part 1: General requirements*

Som svensk standard gäller europastandarden EN 62779-1:2016. Den svenska standarden innehåller den officiella engelska språkversionen av EN 62779-1:2016.

Nationellt förord

Europastandarden EN 62779-1:2016

består av:

- **europastandardens ikraftsättningsdokument**, utarbetat inom CENELEC
- **IEC 62779-1, First edition, 2016 - Semiconductor devices - Semiconductor interface for human body communication - Part 1: General requirements**

utarbetad inom International Electrotechnical Commission, IEC.

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English Version

**Semiconductor devices - Semiconductor interface for human
body communication - Part 1: General requirements
(IEC 62779-1:2016)**

Dispositifs à semiconducteurs - Interface à
semiconducteurs pour les communications via le corps
humain - Partie 1: Exigences générales
(IEC 62779-1:2016)

Halbleiterbauelemente - Halbleiterschnittstelle zur
Kommunikation über den menschlichen Körper -
Teil 1: Allgemeine Anforderungen
(IEC 62779-1:2016)

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European Committee for Electrotechnical Standardization
Comité Européen de Normalisation Electrotechnique
Europäisches Komitee für Elektrotechnische Normung

CEN-CENELEC Management Centre: Avenue Marnix 17, B-1000 Brussels

European foreword

The text of document 47/2267/FDIS, future edition 1 of IEC 62779-1, prepared by IEC/TC 47 "Semiconductor devices" was submitted to the IEC-CENELEC parallel vote and approved by CENELEC as EN 62779-1:2016.

The following dates are fixed:

- latest date by which the document has to be implemented at (dop) 2016-12-24
national level by publication of an identical national
standard or by endorsement
- latest date by which the national standards conflicting with (dow) 2019-03-24
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The text of the International Standard IEC 62779-1:2016 was approved by CENELEC as a European Standard without any modification.

In the official version, for Bibliography, the following note has to be added for the standard indicated :

IEC 62779	NOTE	Harmonized in EN 62779 series.
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CONTENTS

FOREWORD.....	3
INTRODUCTION.....	5
1 Scope.....	6
2 Normative references.....	6
3 Terms, definitions and letter symbols	6
3.1 General terms	6
3.2 Rating and characteristics	7
3.2.1 Input characteristics	7
3.2.2 Transfer characteristics	7
3.3 Letter symbols	9
4 General requirements for HBC semiconductor interface	9
4.1 General specifications	9
4.1.1 General	9
4.1.2 Function	9
4.1.3 Implementation types	10
4.2 Constructional specifications	10
4.3 Electrical specifications	11
4.3.1 General	11
4.3.2 Power supply characteristics	11
4.3.3 Power supply type.....	11
4.3.4 Dynamic characteristics of analog front end.....	11
4.3.5 CDR circuit interface	11
4.3.6 Modem interface	12
4.3.7 Limiting values.....	12
4.3.8 Temperatures	12
4.4 Operating specifications	12
4.4.1 Application.....	12
4.4.2 Grounding condition	13
4.4.3 Contact condition	13
Annex A (informative) General description of HBC	14
Annex B (informative) Generation of powerline noise signal in HBC	15
Annex C (informative) Calculation of sensitivity level	16
Bibliography	17
Figure 1 – Definition of cut-off frequency and bandwidth	8
Figure 2 – Block diagram (example)	10
Figure A.1 – HBC applications	14
Figure B.1 – Coupling of electromagnetic fields and the human body	15
Table 1 – Letter symbols.....	9

INTERNATIONAL ELECTROTECHNICAL COMMISSION

**SEMICONDUCTOR DEVICES –
SEMICONDUCTOR INTERFACE FOR HUMAN BODY COMMUNICATION –****Part 1: General requirements****FOREWORD**

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International Standard IEC 62779-1 has been prepared by IEC technical committee 47:Semiconductor devices.

The text of this standard is based on the following documents:

FDIS	Report on voting
47/2267/FDIS	47/2277/RVD

Full information on the voting for the approval of this standard can be found in the report on voting indicated in the above table.

This publication has been drafted in accordance with the ISO/IEC Directives, Part 2.

A list of all parts in the IEC 62779 series, published under the general title *Semiconductor devices – Semiconductor interface for human body communication*, can be found on the IEC website.

The committee has decided that the contents of this publication will remain unchanged until the stability date indicated on the IEC web site under "<http://webstore.iec.ch>" in the data related to the specific publication. At this date, the publication will be

- reconfirmed,
- withdrawn,
- replaced by a revised edition, or
- amended.

IMPORTANT – The 'colour inside' logo on the cover page of this publication indicates that it contains colours which are considered to be useful for the correct understanding of its contents. Users should therefore print this document using a colour printer.

INTRODUCTION

The IEC 62779 series is composed of three parts as follow:

- IEC 62779-1 defines general requirements of a semiconductor interface for human body communication. It includes general and functional specifications of the interface.
- IEC 62779-2 defines a measurement method on electrical performances of an electrode that constructs a semiconductor interface for human body communication.
- IEC 62779-3 ¹ defines functional type of a semiconductor interface for human body communication, and operational conditions of the interface.

IEC 60748-4 gives requirements on interface integrated circuits for semiconductor devices. Especially, Chapter III, Section 7 in this standard is applied to interface circuits for a communication network using a general channel, such as wire or wireless. However, a channel for HBC is the human body whose channel properties, such as signal loss and delay profile, are different from the general channel, so Chapter III, Section 7 can't be applied to an interface for HBC. Furthermore, a standard on a communication protocol for body area network (BAN) – IEEE 802.15.6, which includes a communication protocol for HBC was published in 2012. A common interface for HBC should be defined to secure communication compatibility between various devices that are implemented on/inside the human body or embedded in peripheral equipments.

¹ To be published.

SEMICONDUCTOR DEVICES – SEMICONDUCTOR INTERFACE FOR HUMAN BODY COMMUNICATION –

Part 1: General requirements

1 Scope

This part of IEC 62779 defines general requirements for a semiconductor interface used in human body communication (HBC). It includes general and functional specifications of the interface, as well as limiting values and its operating conditions.

NOTE Additional information on HBC is provided in Annex A.

2 Normative references

The following documents, in whole or in part, are normatively referenced in this document and are indispensable for its application. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

None.